

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DECAI LI	01/28/2021
SIJIE REN	01/28/2021
YINGSONG LI	01/28/2021
PENG DONG HAN	01/28/2021
RECEIVING PARTY DATA	
Name:	TSINGHUA UNIVERSITY
Street Address:	QINGHUAYUAN
Internal Address:	HAIDIAN DISTRICT
City:	BEIJING
State/Country:	CHINA
Postal Code:	100084
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17212027
CORRESPONDENCE DATA	
Fax Number:	(716)849-0349
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(716)856-4000
Email:	ipdocketing@hodgsonruss.com
Correspondent Name:	HODGSON RUSS LLP
Address Line 1:	140 PEARL STREET
Address Line 2:	SUITE 100
Address Line 4:	BUFFALO, NEW YORK 14202
ATTORNEY DOCKET NUMBER:	075559.10166
NAME OF SUBMITTER:	BLAIR K. ANDREWS
SIGNATURE:	/blair k andrews/
DATE SIGNED:	03/30/2021
Total Attachments: 2	

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ASSIGNMENT OF INVENTION

WHEREAS, we, **Decai LI**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **Sijie REN**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **Yingsong LI**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; and **Pengdong HAN**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, have invented certain new and useful improvements in a MAGNETIC LIQUID SEALING DEVICE, for which an application for Letters Patent in the United States is being filed, claiming priority to Chinese Patent Application No. 202110044066.0 filed on January 13, 2021;

AND WHEREAS, **Tsinghua University**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, is desirous of acquiring all interest in said invention, said application, and in any Letters Patent which may be granted therefor;

AND WHEREAS, at the time the invention was made, we were under an obligation to assign all of our right, title, and interest in said invention to Tsinghua University.

NOW THIS INDENTURE WITNESSETH, that for the sum of one dollar and other valuable consideration to us in hand paid, the receipt of which is hereby acknowledged, we hereby assign, sell, and transfer unto said Tsinghua University our entire right, title, and interest in said invention, said application, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights, rights under the International Convention For The Protection Of Industrial Property, rights under the Patent Cooperation Treaty, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue said United States Letters Patent to said Tsinghua University as the assignee of the whole right, title, and interest thereto.

And we further agree to sign and properly execute such necessary and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and for obtaining any reissue or reissues of any Letters Patent which may be granted for our aforesaid invention, as the assignee thereof shall hereafter require and prepare at its own expense.

WITNESS, our signature and date of execution:

李德才 Dear Li

Decai LI

Date

2021/01/28

任思杰 Sijie Ren

Sijie REN

Date

2021/01/28

李英松 Yingsong Li

Yingsong LI

Date

2021/01/28

韩鹏东 Pengdong HAN

Pengdong HAN

Date

2021/01/28